

PATENT
Docket # 1211030

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

10/114098
04/01/02

1. Assignor: Hsing CHEN
2. Assignee: SOLIDLITE CORPORATION
3F, No. 80, Shan Jeng 9 Road, Ju-Bei City
SHIN CHU, TAIWAN R.O.C.
3. Nature of Conveyance: Assignment of patent
4. Reference number: Application filed herewith.
5. Correspondence to: Keith Kline
PRO-TECHTOR INTERNATIONAL
20775 Norada Court
Saratoga, CA 95070-3018
6. Number of applications affected by this recording: 1
Total Fee (= # of apps x \$40.00) = \$40.00

Authorization is hereby given to charge the above to deposit account # 16-2497.


7. Execution date of the document to be recorded: 03/26/02
8. Total number of pages including cover sheet: 2

9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.

10. CERTIFICATE OF MAILING (37 CFR 1.10): I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as Express Mail in an envelope addressed to: Box New Applications, The Assistant Commissioner for Patents, Washington, D.C. 20231.

Respectfully submitted,

Date: April 1, 2002


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ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR

Assignor's Name	Assignor's Residence and/or Address	Nationality
(1) Hsing Chen	3F, NO. 80, SHAN JENG 9 ROAD, JU-BEI CITY, SHIN CHU, TAIWAN, R.O.C.	Taiwan, R.O.C.
(2)		
(3)		
(4)		

hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
SOLIDLITE CORPORATION	3F, NO. 80, SHAN JENG 9 ROAD, JU-BEI CITY, SHIN CHU, TAIWAN, R.O.C.	Taiwan, R.O.C.

and the successors, assigns and legal representatives of the ASSIGNEE

[check one of the following]

☒ the entire right, title, and interest ☐ an undivided _____ percent (____%) interest

in and to any and all improvements which are disclosed in the invention entitled: LIGHT EMITTING DIODE LAMP

_____, and which is found in [check one of the following]

(a) ☒ U.S. patent application executed on march 26, 2002.

(b) ☐ U.S. patent application serial number _____, filed on _____

(c) ☐ U.S. patent number _____, issued on _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to Letters Patent any reissued or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(1) <u>Hsing Chen</u>	Hsing Chen	2002.3.26
(2)		
(3)		
(4)		